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SPECIFICATION FOR LCM MODULE

MODULE NO.: AMC4002BR-B-Y6NRN DOC.REVISION 00

Customer Approval:

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		Dec-30-2007
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		

DOCUMENT REVISION HISTORY

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00	Dec-30-2007	First issue	Dong

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1. FUNCTIONS & FEATURES

1.1. Format : 40x2 characters

1.2. LCD mode : STN / Positive/ Reflective/ Y-G

1.3. Viewing direction : 6 O'clock

1.4. Driving scheme : 1/16 Duty, 1/5 Bias

1.5. Power supply voltage (V_{DD}): 5.0V1.6. LCD driving voltage(Vop): 4.5V1.7. Operation temp: $0 \sim 50 \,^{\circ}\text{C}$ 1.8. Storage temp: $-20 \sim 70 \,^{\circ}\text{C}$ 1.9. Backlight color: None

1.10. RoHS standard

2. MECHANICAL SPECIFICATIONS

2.1. Module size : 182.0mm(L)*33.5mm(W)*9.3 mm(H)max

 2.2. Viewing area
 : 154.5mm(L)*15.8mm(W)

 2.3 Character pitch
 : 3.70mm(L)*5.95mm(W)

 2.4 Character size
 : 3.20mm(L)*5.55mm(W)

 2.5. Dot pitch
 : 0.65mm(L)*0.70mm(W)

 2.6. Dot size
 : 0.60mm(L)*0.65mm(W)

2.7. Weight : Approx.

3. BLOCK DIAGRAM

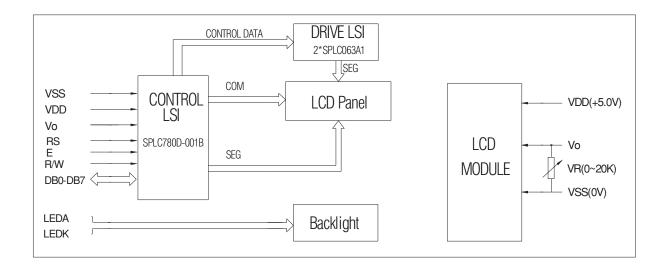


Figure 2. Block diagram

4. DIMENSIONAL OUTLINE

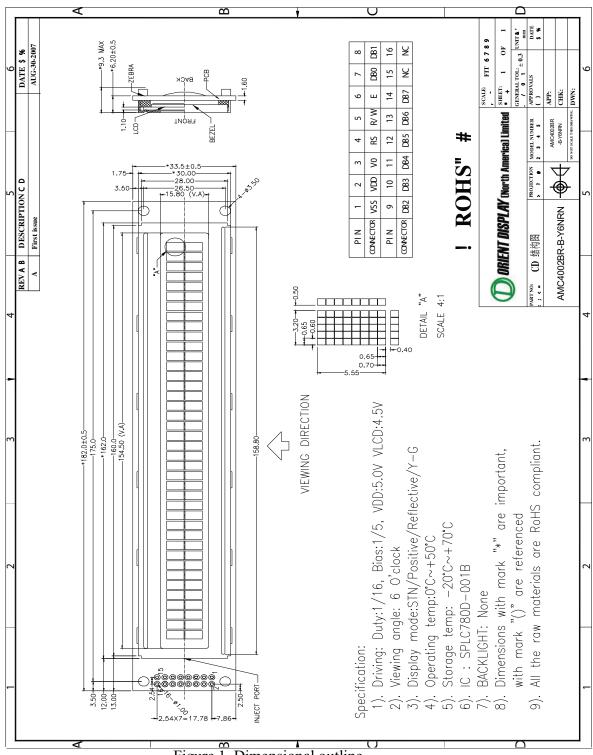


Figure 1. Dimensional outline

5. PIN DESCRIPTION

No.	Symbol	Function
1	VSS	Power ground (0V)
2	VDD	Power supply for Logic(+5V)
3	V0	Power supply for LCD drive
4	RS	Register selection (H: Data register, L:Instruction register)
5	R/W	Read/write selection (H: Read, L: Write)
6	Е	Enable signal.
7-14	DB0~DB7	Data Bus line
15	NC	No Connection
16	NC	No Connection

6. MAXIMUM ABSOUTE LIMIT

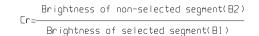
Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	V_{DD}	-0.3	7.0	V
Supply Voltage for LCD	V0	V _{DD} -12.0	V _{DD} +0.3	V
Input Voltage	Vin	-0.3	V _{DD} +0.3	V
Operating Temperature	Top	0	50	$^{\circ}\mathbb{C}$
Storage Temperature	Tst	-20	70	$^{\circ}\mathbb{C}$

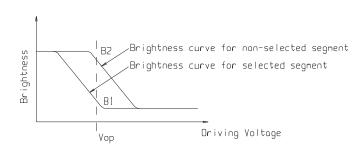
7. ELECTRICAL CHARACTERISTICS

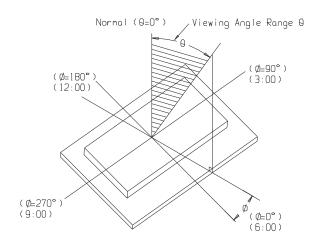
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	Vdd-Vss	Ta = 25°C	4.8	5.0	5.2	V
Input High Voltage	VIH	Ta = 25°C	$0.7V_{\mathrm{DD}}$		V_{DD}	V
Input Low Voltage	VIL	Ta = 25°C	-0.3		0.2 Vdd	V
Output High Voltage(TTL)	Voh	Ta = 25°C	0.75V _{DD}			V
Output Low Voltage(TTL)	Vol	Ta = 25°C			$0.2V_{\mathrm{DD}}$	V
Supply Current	Idd	Ta = 25°C			3.0	mA

8. ELECTRO-OPTICAL CHARACTERISTICS ($V_{OP} = 4.5V$, Ta = 25°C)

Item	Symbo 1	Condition	Min	Тур	Max	Unit	
		Ta = -20°C	4.9				
Operating Voltage	Vop	$Ta = 25^{\circ}C$	4.2	4.5	4.8	V	
		$Ta = 70^{\circ}C$	3.7	3.9	4.0		
Pagnanga tima	Tr	Ta = 25°C		185		ms	
Response time	Tf	1a-25 C		200		ms	
Contrast	Cr	$Ta = 25^{\circ}C$		4			
Viewing angle range	()	C. > 2	-40		+40	deg	
	Φ	Cr≥2	-40		+40	deg	







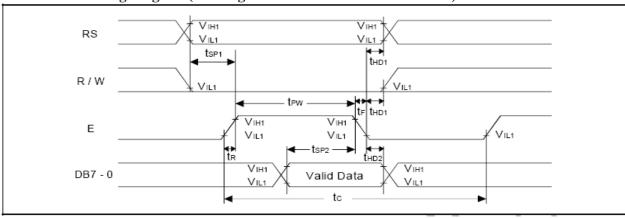
9. TIMING CHARACTERISTICS Write mode(writing data from MPU to SPLC780D)

Characteristics	Cumbal		Limit		Unit	Test Condition	
Characteristics	Symbol	Min.	Тур.	Max.		Test Colldition	
E Cycle Time	tc	1000	-		ns	Pin E	
E Pulse Width	t _{PW}	450	-		ns	Pin E	
E Rise/Fall Time	t _R , t _F	-	(25	ns	Pin E	
Address Setup Time	t _{SP1}	60	-		ns	Pins: RS, R/W, E	
Address Hold Time	t _{HD1}	20)	-	ns	Pins: RS, R/W, E	
Data Setup Time	t _{SP2}	195	2		ns	Pins: DB0 - DB7	
Data Hold Time	t _{HD2}	10		7	ns	Pins: DB0 - DB7	

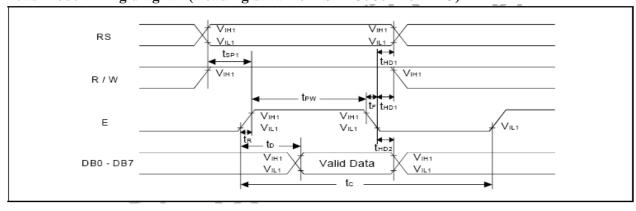
Read mode(reading data from SPLC780D to MPU)

		_				
Characteristics	Symbol	Min.	Limit Typ.	Max.	Unit	Test Condition
			- 17 P.	- 111322		
E Cycle Time	J to →	1000	-	-	ns	Pin E
E Pulse Width	tw	450	-	-	ns	Pin E
E Rise/Fall Time	te, te		-	25	ns	Pin E
Address Setup Time	tsei	60	-	-	ns	Pins: RS, R/W, E
Address Hold Time	thei	20	-	-	ns	Pins: RS, R/W, E
Data Output Delay Time	to	-	-	360	ns	Pins: DB0 - DB7
Data hold time	t _{HD2}	5.0	-	-	ns	Pin DB0 - DB7

Write mode timing diagram(Writing data from MPU to SPLC780D)



Read mode timing diagram(Reading data from SPLC780D to MPU)



10. CONTROL AND DISPLAY COMMAND

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In a town a state of				Ins	tructi	on Co	ode				Execution tin			
Instruction	RS	RW	DB7	npe	DB5	DP4	DP?	ne?	DB1	DPA	Description	Fosc=	Fosc=	Fosc=
	к3	KW	ומט	DB6	DBS	DB4	DB3	UBZ	ומט	DBO		190KHz	270KHz	350KHz
Clear Display	0	а	0	0	0	О	o	0	С	1	Write "20H" to DDRAM and set DDRAM address to "00H" from AC	2.15ms	1.52ms	1.18ms
Return Home	0	0	0	0	0	0	0	0	1	-	Set DDRAM address to "DDII" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	2.16ms	1.52ms	1.18ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Assign cursor moving direction and enable the shift of entire display	53µs	38µs	29µs
Display ON/ OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor(C), and blinking of cursor(B) on/off control bit.	53µs	38µs	29µs
Cursor or Display Shift	0	0	0	0	0	1	SIC	R/L			Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	53µs	38µs	29µs
Function Set	0	٥	6	6	0;- !	占	Z				Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F:5x10 dots/5x8 dots)	53µs	38µs	29µs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	53µs	38µs	29µs
Set DDRAM Address	0	0	\odot	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	53µs	38μs	29µs
Read Busy Flag and Address Counter	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.			
Write Data to RAM	1	О	D7	D6	D5	D4	D3	D2	D1	DD	Write data into internal RAM (DDRAM/CGRAM).	53µз	38µз	29µз
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	DD	Read data from internal RAM (DDRAM/CGRAM).	53με	38με	29µs

Note1: "--": don't care

Note2: In the operation condition under -20°C ~ 75°C, the maximum execution time for majority of instruction sets is 100us, except two instructions, "Clear Display" and "Return Home", in which maximum execution time can take up to 4.1ms.

11. Font Characteristic

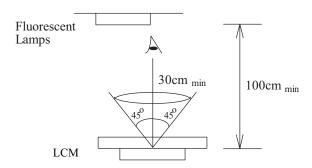
11. F	JIIL	CII	ai a		1901											
Upper 4 hit Lower 4 hit	ш	штн	LLHL	LIHH	LHLL	LHLH	LHHL	LHHH	нпт	ншн	HLHL	нин	HHLL	нн.н	нянь	ннн
LLLL				Ø	۵	P		P					7	=	œ	P
LLIH				1	A			-				P	Ŧ	4		
LLHL				2	B	R	b	r			ш		!!!!!	×		
LLHH			ш	ĕ	ш	\blacksquare	ш	ш					T	E	٤.	**
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12.QUALITY SPECIFICATIONS

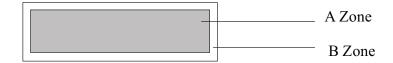
12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area). B Zone: Non-active display area (outside viewing area).

12.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
Polarizer		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Note on defect classification

No.	Item	Criterion		
1	Short or open circuit	Not allow		
	LC leakage			
	Flickering			
	No display			
	Wrong viewing direction			
	Wrong Back-light			
2	Contrast defect	Refer to approval sample		
	Background color deviation			
3	Point defect, Black spot, dust (including Polarizer) = (X+Y)/2	Point Size 0.10 Disregard 0.10 $9 \le 0.20$ 3 0.20 $9 \le 0.25$ 2 0.25 $9 \le 0.30$ 1 0.30 $0 \le 0.30$ 0 Unit: mm		
4	Line defect, Scratch	$\begin{array}{c ccccc} & & & & & & \\ & & & & & \\ L & & & & & \\ & & L & & & \\ & & & L & & \\ & & & &$		
5	Rainbow	Not more than two color changes across the viewing area.		

No	Item	Criterion		
6	Chip Remark: X: Length direction Y: Short	Acceptable criterion $\begin{array}{c cccc} X & Y & Z \\ \hline Z & 0.5 \text{mm} & \leqslant t/2 \end{array}$		
	direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
		Acceptable criterion $\begin{array}{ c c c c c c c c c c c c c c c c c c c$		
		Acceptable criterion $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		

No.	Item	Criterion		
7	Segment pattern $W = Segment width$ $(X+Y)/2$	(1) Pin hole (2) ≤ 0.10mm is acceptable. (3) × × × × × × × × × × × × × × × × × × ×		
		Point Size Acceptable Qty $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		
8	Back-light	(1) The color of backlight should correspond its specification.		
9	Soldering	(2) Not allow flickering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead		
10	Wire PCB	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable. (1) Not allow screw rust or damage. 		
		(2) Not allow missing or wrong putting of component.		

No	Item	Criterion	
12	Protruded W: Terminal Width	Acceptable criteria: $Y \boxtimes 0.4$	
13	TAB	1. Position $\begin{array}{cccccccccccccccccccccccccccccccccccc$	
		2 TAB bonding strength test TAB P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)	
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.	

12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	70°C	48	
High temp. Operating	50°C	48	
Low temp. Storage	-20°C	48	No abnormalities
Low temp. Operating	0°C	48	in functions
Humidity	40°C / 90%RH	48	and appearance
Temp. Cycle	0°C ~25°C ~50°C	10cycles	
	$(30 \min \sim 5 \min \sim 30 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting Orient Display.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.

7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280 a C+10 C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40 aC is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

Orient Display LCDs and modules are not consumer products, but may be incorporated by Orient Display's customers into consumer products or components thereof, Orient Display does not warrant that its LCDSs and components are fit for any such particular purpose.

- 1. The liability of Orient Display is limited to repair or replacement on the terms set forth below. Orient Display will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Orient Display and the customer, Orient Display will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Orient Display general LCD inspection standard.(Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.